TEXAS INSTRUMENTS Bill of Materials

PMP10535

ltem	Qty Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	PCB Footprint	Note
1	1 R7	301k	RES, 301 k, 1%, 0.063 W, 0603	TE Connectivity	1879339-3	0603	
2	1 GND	Black	Test Point, Miniature, Black, TH	Keystone	5001	Keystone5001	
3	1 R6	100k	RES, 100 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603100KFKEA	0603	
4	1 R8	143k	RES, 143 k, 1%, 0.1 W, 0603	Vishay-Dale	71-CRCW0603-143K-E3	0603	
5	1 R10	20.0k	RES, 20.0 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW060320K0FKEA	0603	
6	1 R9	8.87k	RES, 8.87 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW06038K87FKEA	0603	
7	1 R5	40.2k	RES, 40.2 k, 1%, 0.1 W, 0603	Yageo America	RC0603FR-0740K2L	0603	
8	1 D5	45V	Diode, Schottky, 45 V, 0.1 A, SOD-523	Diodes Inc.	SDM10U45-7	SOD-523	
9	1 U1		100V Constant On-Time PFET Buck Switching Controller, 8-pin PSOP, Pb-Free	Texas Instruments	LM5017MRX-ND	MRA08A_N	
10	1 C8	1000pF	CAP, CERM, 1000 pF, 25 V, +/- 5%, COG/NP0, 0603	MuRata	GRM1885C1E102JA01D-ND	0603	
11	1 C11	1uF	CAP, CERM, 1 μF, 16 V, +/- 10%, X5R, 0603	TDK	C1608X5R1C105K080AA	0603	
12	1 C13	0.1uF	CAP, CERM, 0.1 μF, 100 V, +/- 10%, X7R, 0805	TDK	C2012X7R2A104K125AA	0805_HV	
13	1 C3	1000pF	CAP, CERM, 1000 pF, 1000 V, +/- 5%, COG/NP0, 1210	Vishay-Vitramon	VJ1210A102JXGAT5Z	1210	
14	1 C12	1uF	CAP, CERM, 1 μF, 100 V, +/- 10%, X7R, 1210	TDK	C3225X7R2A105K200AA	1210	
15	1 T1	45uH	XFMR, SMT 45uH, 750314460	Wurth Elektronik	750314460	XFMR_Wurth_750314460_12pin_SMT	
16	2 FB, SW	Red	Test Point, Miniature, Red, TH	Keystone	5000	Keystone5000	
17	2 R3, R4	1.00k	RES, 1.00 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW06031K00FKEA	0603	
18	2 R1, R2	2.00k	RES, 2.00 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW06032K00FKEA	0603	
19	2 C6, C7	0.01uF	CAP, CERM, 0.01 µF, 25 V, +/- 5%, C0G/NP0, 0603	TDK	C1608C0G1E103J080AA	0603	
20	2 C4, C5	2.2uF	CAP, CERM, 2.2 μF, 16 V, +/- 10%, X7R, 0805	Kemet	C0805C225K4RACTU	0805_HV	
21	2 C1, C2	2.2uF	CAP, CERM, 2.2 μF, 25 V, +/- 10%, X5R, 0805	MuRata	GRM21BR61E225KA12L	0805_HV	
22	2 C9, C10	10uF	CAP, CERM, 10 μF, 25 V, +/- 20%, X7R, 1210	TDK	C3225X7R1E106M250AC	1210	
23	4 D1, D2, D3, D4	90V	Diode, Schottky, 90 V, 1 A, SOD-123	Rohm	RB160M-90TR	SOD-123	
24	10 5VN, 5VP, 12VN, 12VP, GND1, GND2, IGND1, IGND2,	, Vin, Vopri Double	Terminal, Turret, TH, Double	Keystone	1502-2	Keystone1502-2	

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